## In the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application.

- 1. (Cancelled)
- 2. (New) A method for continuous electroplating of a metal-based deposit onto at least a portion of the surface of an article wherein said portion is formed by an electroplateable material, the improvement comprising;
  - formulating said electroplateable material comprising an electrically conductive polymer.
- 3. (New) The method according to claim 2 wherein said electrically conductive polymer is a directly electroplateable resin (DER).
- 4. (New) A method for continuous electroplating of a selected metal-based deposit, the improvement comprising;
  - formulating an electroplateable material comprising an electrically conductive polymer.
  - providing an article characterized by having a selected portion of the surface of the article formed by said electroplateable material.
- 5. (New) A method according to claim 4 wherein said article comprises a web.
- 6. (New) A method according to claim 4 wherein said electrically conductive polymer is a directly electroplateable resin (DER).
- 7. (New) An article comprising an electrically conductive polymer and a metal-based electrodeposit contacting at least a portion of said electrically conductive polymer wherein said article is produced by continuous electroplating of said metal-based electrodeposit.

- 8. (New) The article of claim 7 wherein said article comprises a continuous web.
- 9. (New) The article of claim 7 wherein said electrically conductive polymer comprises a DER.